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STD28P3LLH6AG

Automotive-grade P-channel -30 V, 0.027 Ω typ., -12 A STripFET™ H6 Power MOSFET in a DPAK package

Datasheet - production data

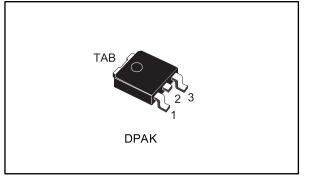
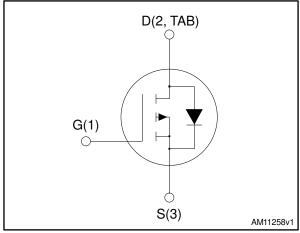


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ρτοτ
STD28P3LLH6AG	-30V	0.030Ω	-12A	33W

- Designed for automotive applications and AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss
- Logic level

Applications

• Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFETTM H6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{DS(on)}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
STD28P3LLH6AG	28P3LLH6	DPAK	Tape and reel

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	-30	V
V _{GS}	Gate-source voltage	±18	V
I _D ⁽¹⁾	Drain current (continuous) at $T_{case} = 25 \text{ °C}$		٨
ID, ,	Drain current (continuous) at T _{case} = 100 °C	-12	A
I _{DM} ⁽²⁾	Drain current (pulsed)	-48	А
Ρτοτ	Total dissipation at T _{case} = 25 °C	33	W
Eas ⁽³⁾	Single pulse avalanche energy	210	mJ
T _{stg}	Storage temperature	–55 to 150	°C
Tj	Maximum operating junction temperature	150	°C

Notes:

⁽¹⁾Limited by wire bonding

⁽²⁾ Pulse width is limited by safe operating area.

 $^{(3)}$ starting T_j = 25 °C, I_{AS} =-6 A, V_{DD} = -25 V, V_{gs} = -10 V .

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	3.75	0 0 AM	
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W	

Notes:

 $^{(1)}$ When mounted on a 1-inch² FR-4, 2 Oz copper board



2 Electrical characteristics

 $(T_{case} = 25 \text{ °C unless otherwise specified})$

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I _D = -250 μ A	-30			V
	Zara gata valtaga drain	V_{GS} = 0 V, V_{DS} = -30 V			-1	
I _{DSS}	Zero gate voltage drain current	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = -30 \ V, \\ T_{case} = 125 \ ^{\circ}\text{C} \end{array}$			-10	μA
I _{GSS}	Gate-body leakage current	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 18 \text{ V}$			±100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS}=V_{GS},I_{D}=-250\;\mu A$	-1		-2.5	V
Static drain-source on-		$V_{GS} = -10 V, I_D = -6 A$		0.027	0.03	Ω
R _{DS(on)}	resistance	$V_{GS}=-4.5~V,~I_{D}=-6~A$		0.038	0.05	Ω

Table 5: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1480	-	
Coss	Output capacitance	V _{DS} = -25 V, f = 1 MHz, V _{GS} = 0 V	-	170	-	pF
C _{rss}	Reverse transfer capacitance			125	-	
Qg	Total gate charge	$V_{DD} = -15 \text{ V}, I_D = -12 \text{ A}, V_{GS} = -10 \text{ V}$ (see Figure 14: "Gate charge test circuit")		29	-	
Q _{gs}	Gate-source charge			4.7	-	nC
Q _{gd}	Gate-drain charge		-	5.6	-	

Table 6: Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	10	-	
tr	Rise time	$V_{DD} = -15 \text{ V}, \text{ I}_D = -6 \text{ A} \text{ R}_G = 4.7 \Omega,$	-	7.9	-	
$t_{d(off)}$	Turn-off delay time	$V_{GS} = -10 V$ (see Figure 13: "Switching times test circuit for resistive load")	-	41.5	-	ns
t _f	Fall time		-	6.9	-	



Electrical characteristics

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	Table 7: Source-drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
I _{SD}	Source-drain current		-		-12	А	
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		-48	А	
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = -12 A$	-		-1.3	V	
t _{rr}	Reverse recovery time		-	17.8		ns	
Q _{rr}	Reverse recovery charge	I_{SD} = -12 A, di/dt = 100 A/µs, V _{DD} = -24 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	10.2		nC	
I _{RRM}	Reverse recovery current		-	-1.2		А	

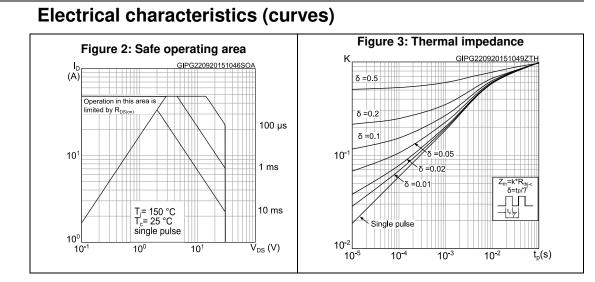
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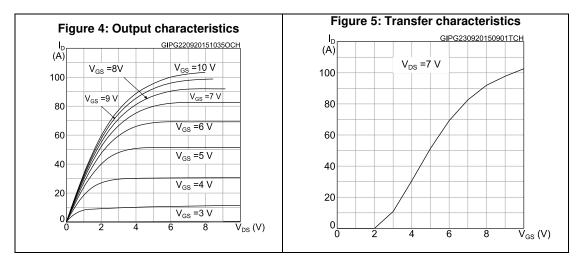
 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

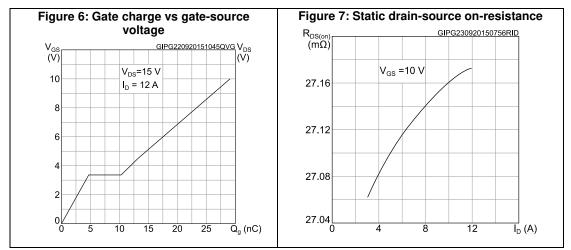
 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



2.2





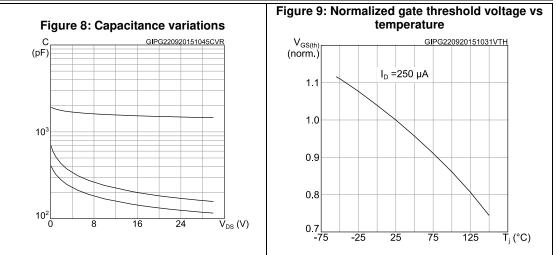


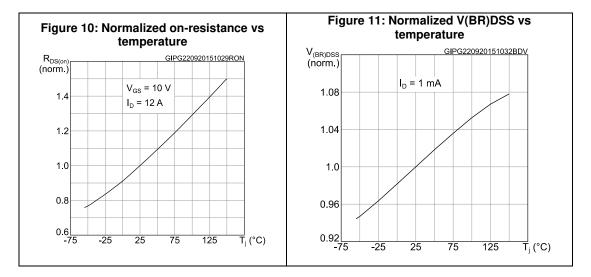
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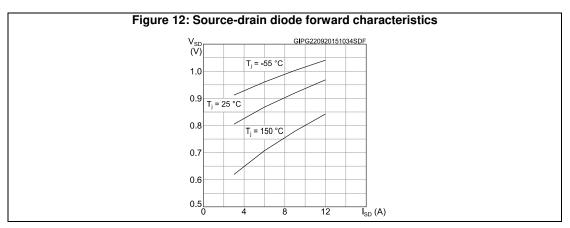


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Electrical characteristics



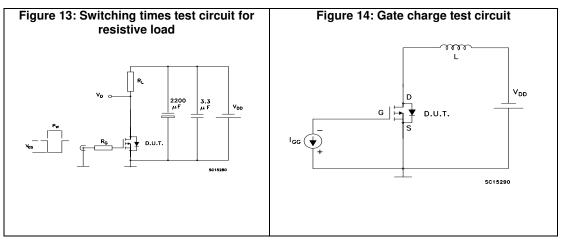


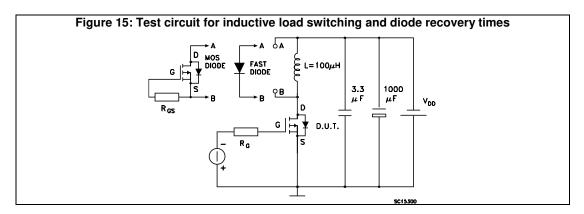


For the P-channel Power MOSFET, current and voltage polarities are reversed.

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3 Test circuits







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 DPAK (TO-252) type A package information

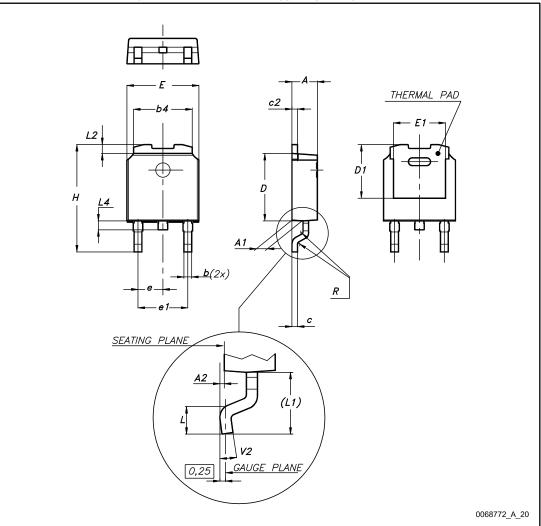


Figure 16: DPAK (TO-252) type A package outline



Package information

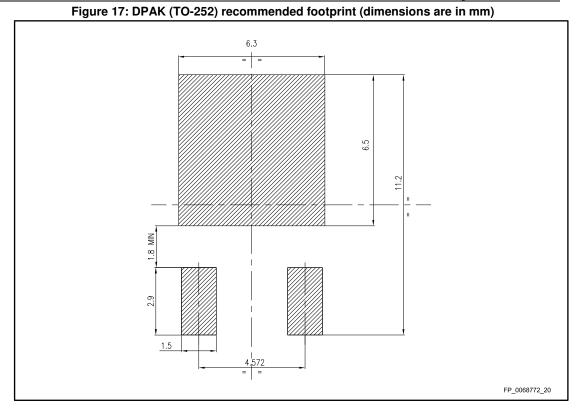
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formation	ormation STD28P3LLH6AG Table 8: DPAK (TO-252) type A mechanical data					
	Table 8: DPAK (10-252		la			
Dim.	mm					
	Min.	Тур.	Max.			
A	2.20		2.40			
A1	0.90		1.10			
A2	0.03		0.23			
b	0.64		0.90			
b4	5.20		5.40			
С	0.45		0.60			
c2	0.48		0.60			
D	6.00		6.20			
D1	4.95	5.10	5.25			
E	6.40		6.60			
E1	4.60	4.70	4.80			
е	2.16	2.28	2.40			
e1	4.40		4.60			
Н	9.35		10.10			
L	1.00		1.50			
(L1)	2.60	2.80	3.00			
L2	0.65	0.80	0.95			
L4	0.60		1.00			
R		0.20				
V2	0°		8°			

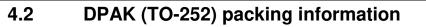


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Package information







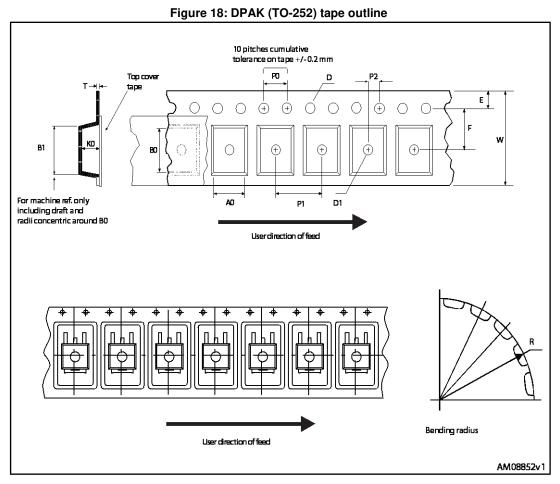




Figure 19: DPAK (TO-252) reel outline

Package information

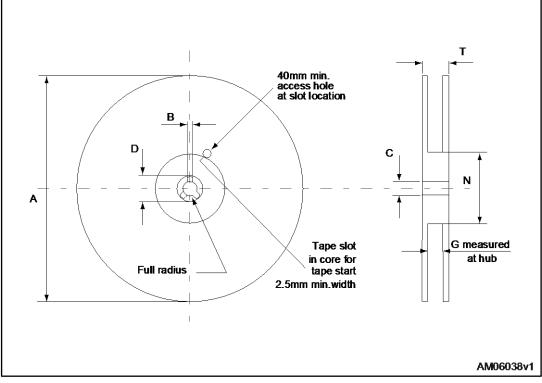


Table 9: DPAK (TO-252) tape and reel mechanical data					
	Таре			Reel	
Dim	n	nm	Dim	n	nm
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	А		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	Ν	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base	e qty.	2500
P1	7.9	8.1	Bulk	qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

Table 9: DPAK (TO-252) tape and reel mechanical data



Revision history 5

Table 10: Document revision history

Date	Revision	Changes
21-Sep-2015	1	First release.



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